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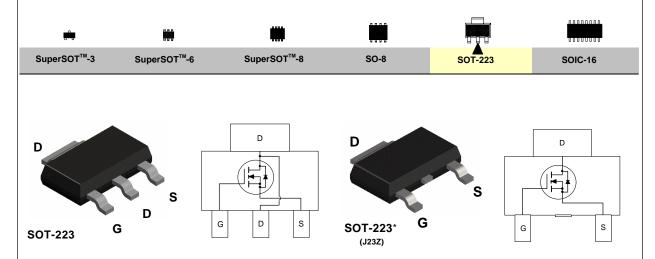
# FDT457N N-Channel Enhancement Mode Field Effect Transistor

#### **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance. These products are well suited to low voltage, low current applications such as notebook computer power management, battery powered circuits, and DC motor control.

## Features

- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.



# **Absolute Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

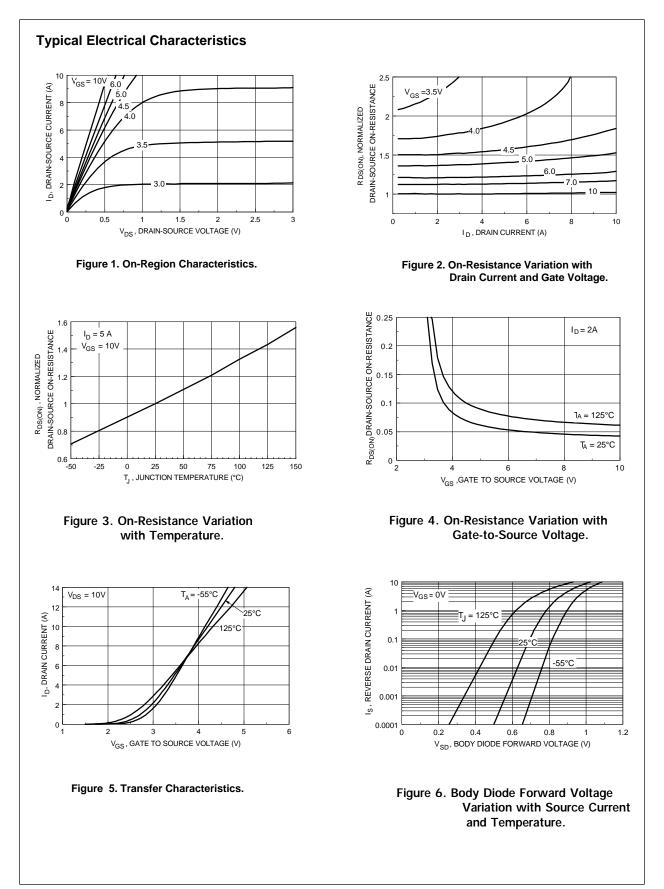
Symbol	Parameter	FDT457N	Units
V <sub>DSS</sub>	Drain-Source Voltage	30	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous	±20	V
I <sub>D</sub>	Maximum Drain Current - Continuous (Note 1a)	5	А
	- Pulsed	16	
P <sub>D</sub>	Maximum Power Dissipation (Note 1a)	3	W
	(Note 1b)	1.3	
	(Note 1c)	1.1	
「」,T <sub>stg</sub>	Operating and Storage Temperature Range	-65 to 150	°C
<b>THERMA</b>	L CHARACTERISTICS		
R <sub>eja</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)	42	°C/W
۲ <sub>өлс</sub>	Thermal Resistance, Junction-to-Case (Note 1)	12	°C/W

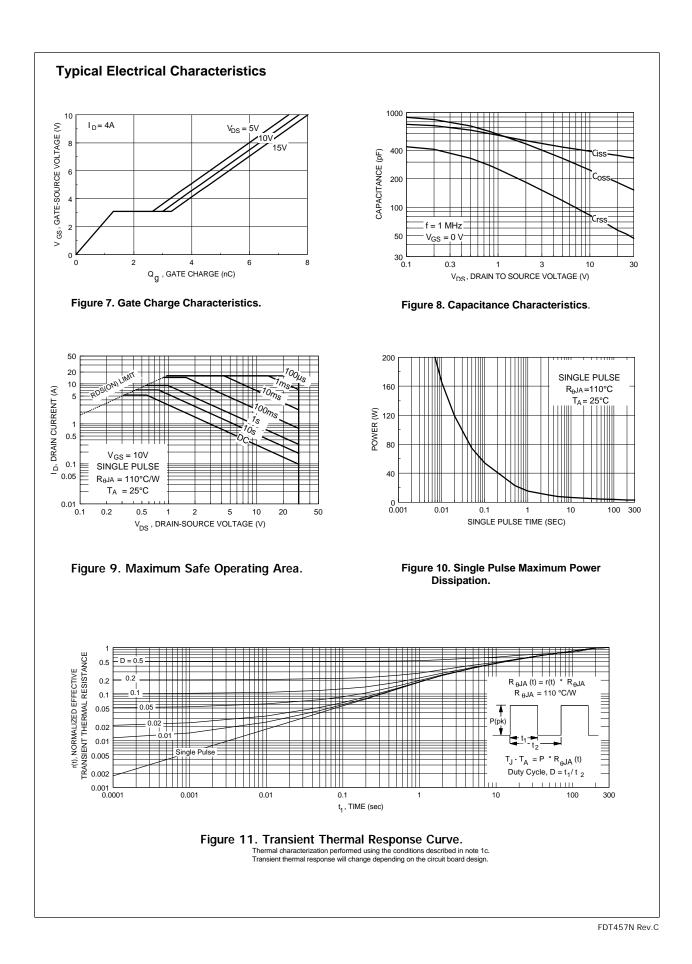
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
3V <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C			35		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				1	μA
033			T_=55°C			10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	, ,			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)						
/ <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp.Coefficient	$I_{\rm D}$ = 250 µA, Referenced t	o 25 ℃		-4.2		mV/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$			0.043	0.06	Ω
D3(ON)		63 . 5	T_=125°C		0.065	0.1	-
		$V_{GS} = 4.5 \text{ V}, I_{D} = 3.8 \text{ A}$	J		0.071	0.09	
D(ON)	On-State Drain Current	$V_{gs} = 10 \text{ V}, \text{ V}_{ps} = 5 \text{ V}$		5			А
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$			5		S
-	HARACTERISTICS	53 / 5					1
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			235		pF
C <sub>oss</sub>	Output Capacitance				145		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				50		pF
	CHARACTERISTICS (Note 2)						
D(on)	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			5	10	ns
- () r	Turn - On Rise Time				12	22	ns
D(off)	Turn - Off Delay Time				12	22	ns
- () f	Turn - Off Fall Time				3	8	ns
$\mathbf{Q}_{g}$	Total Gate Charge	$V_{DS} = 10 \text{ V}, \ \text{I}_{D} = 5 \text{ A},$			4.2	5.9	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$			1.3		nC
 Q <sub>gd</sub>	Gate-Drain Charge	-			1.7		nC
-	RCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS					1
Is	Maximum Continuous Drain-Source Diode Fo	rward Current				2.5	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.5 \text{ A}$ (Note	2)		0.85	1.2	V
-	a. 42°C/W when mounted on a 1 in² pad of 2oz Cu.	b. 95°C/W when mount 0.066 in <sup>2</sup> pad of 2oz Cu	ed on a		c. 110°C/W n in² pad of 2c	when mount	bins. R <sub>euc</sub> is

2. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%





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